

General Description

This IGBT is produced using advanced Magnachip's Field Stop Trench IGBT Technology, which provides low $V_{CE(sat)}$, high switching performance and excellent quality.

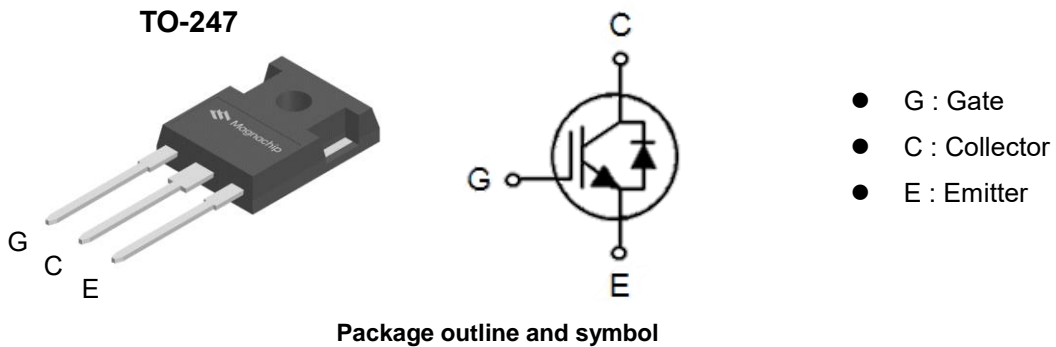
This device is for PFC, UPS & Inverter applications.

Applications

- Welder

Features

- High Speed Switching & Low Power Loss
- $V_{CE(sat)} = 2.1V @ I_C = 40A$
- High Input Impedance
- $t_{rr} = 285ns$ (typ.)
- Ultra-Soft, fast recovery anti-parallel diode
- Ultra-narrowed V_F distribution control
- Positive Temperature coefficient for easy paralleling



Absolute Maximum Ratings

| Characteristics | | Symbol | Rating | Unit |
|--|-------------------|-------------|----------|------------|
| Collector-emitter voltage | | V_{CES} | 1200 | V |
| Gate-emitter voltage | | V_{GE} | ± 20 | V |
| DC collector current, limited by T_{vjmax} | $T_C=25^\circ C$ | I_C | 80 | A |
| | $T_C=100^\circ C$ | | 40 | A |
| Pulsed collector current, t_p limited by T_{vjmax} | | I_{Cpuls} | 160 | A |
| Diode forward current, limited by T_{vjmax} | $T_C=25^\circ C$ | I_F | 80 | A |
| | $T_C=100^\circ C$ | | 40 | A |
| Diode pulsed current, Pulse time limited by T_{jmax} | | I_{Fpuls} | 160 | A |
| Power dissipation | $T_C=25^\circ C$ | P_D | 428 | W |
| | $T_C=100^\circ C$ | | 214 | W |
| Short circuit withstand time $V_{CE} = 500V, V_{GE} = 15V, T_C = 150^\circ C$ | | t_{SC} | 3 | μs |
| Operating Junction temperature range | | T_{vj} | -40~175 | $^\circ C$ |
| Storage temperature range | | T_{stg} | -55~150 | $^\circ C$ |

Thermal Characteristics

| Characteristics | Symbol | Rating | Unit |
|---|---------------|--------|--------------|
| Thermal resistance junction-to-ambient | $R_{th(j-a)}$ | 40 | $^\circ C/W$ |
| Thermal resistance junction-to-case for IGBT | $R_{th(j-c)}$ | 0.35 | |
| Thermal resistance junction-to-case for Diode | $R_{th(j-c)}$ | 0.8 | |

Ordering Information

| Part Number | Marking | Temp. Range | Package | Packing | RoHS Status |
|----------------|-----------|-------------|---------|---------|--------------|
| MBQ40T120QESTH | 40T120QES | -55~150°C | TO-247 | Tube | Halogen Free |

Electrical Characteristics (T_{vj} = 25°C unless otherwise specified)

| Characteristics | Symbol | Conditions | Min | Typ | Max | Unit | |
|--------------------------------------|----------------------|--|-------------------------|-----|------|------|---|
| Static Characteristics | | | | | | | |
| Collector-emitter breakdown voltage | BV _{CES} | I _C = 1mA, V _{GE} = 0V | 1200 | - | - | V | |
| Collector-emitter saturation voltage | V _{CE(sat)} | I _C = 40A, V _{GE} = 15V | T _{vj} = 25°C | - | 2.1 | 2.7 | V |
| | | | T _{vj} = 175°C | - | 2.75 | - | |
| Diode forward voltage | V _F | V _{GE} = 0V, I _F = 40A | T _{vj} = 25°C | - | 1.95 | 2.50 | V |
| | | | T _{vj} = 175°C | - | 2.05 | - | |
| Gate-emitter threshold voltage | V _{GE(th)} | V _{CE} = V _{GE} , I _C = 1mA | 4.0 | 5.0 | 6.0 | V | |
| Zero gate voltage collector current | I _{CES} | V _{CE} = 1200V, V _{GE} = 0V | - | - | 1 | mA | |
| Gate-emitter leakage current | I _{GES} | V _{GE} = 20V, V _{CE} = 0V | - | - | ±250 | nA | |

Dynamic Characteristics

| | | | | | | |
|------------------------------|------------------|--|---|------|---|----|
| Total gate charge | Q _g | V _{CE} = 960V, I _C = 40A, V _{GE} = 15V | - | 428 | - | nC |
| Gate-emitter charge | Q _{ge} | | - | 56 | - | |
| Gate-collector charge | Q _{gc} | | - | 232 | - | |
| Input capacitance | C _{ies} | V _{CE} = 30V, V _{GE} = 0V, f = 1MHz | - | 6780 | - | pF |
| Output capacitance | C _{oes} | | - | 158 | - | |
| Reverse transfer capacitance | C _{res} | | - | 86 | - | |

Switching Characteristics

| | | | | | | | |
|---------------------------|---------------------|--|--|------|------|----|----|
| Turn-on delay time | t _{d(on)} | V _{GE} = 15V, V _{CC} = 600V, I _C = 40A, R _G = 10Ω, Inductive Load, T _{vj} = 25°C | - | 74 | - | ns | |
| Rise time | t _r | | - | 114 | - | | |
| Turn-off delay time | t _{d(off)} | | - | 178 | - | | |
| Fall time | t _f | | V _{GE} = 15V, V _{CC} = 600V, I _C = 40A, R _G = 10Ω, Inductive Load, T _{vj} = 175°C | - | 95 | - | mJ |
| Turn-on switching energy | E _{on} | | | - | 5.13 | - | |
| Turn-off switching energy | E _{off} | | | - | 0.77 | - | |
| Total switching energy | E _{ts} | - | | 5.90 | - | ns | |
| Turn-on delay time | t _{d(on)} | - | | 67 | - | | |
| Rise time | t _r | - | | 122 | - | | |
| Turn-off delay time | t _{d(off)} | V _{GE} = 15V, V _{CC} = 600V, I _C = 40A, R _G = 10Ω, Inductive Load, T _{vj} = 175°C | - | 193 | - | mJ | |
| Fall time | t _f | | - | 134 | - | | |
| Turn-on switching energy | E _{on} | | - | 7.47 | - | | |
| Turn-off switching energy | E _{off} | | - | 1.44 | - | ns | |
| Total switching energy | E _{ts} | | - | 8.91 | - | | |
| Reverse recovery time | t _{rr} | | I _F = 40A, di _F /dt = 300A/μs, T _{vj} = 25°C | - | 285 | | - |
| Reverse recovery current | I _{rr} | - | | 15 | - | A | |
| Reverse recovery charge | Q _{rr} | - | | 2.09 | - | uC | |
| Reverse recovery time | t _{rr} | I _F = 40A, di _F /dt = 300A/μs, T _{vj} = 175°C | - | 472 | - | ns | |
| Reverse recovery current | I _{rr} | | - | 20 | - | A | |
| Reverse recovery charge | Q _{rr} | | - | 4.55 | - | uC | |

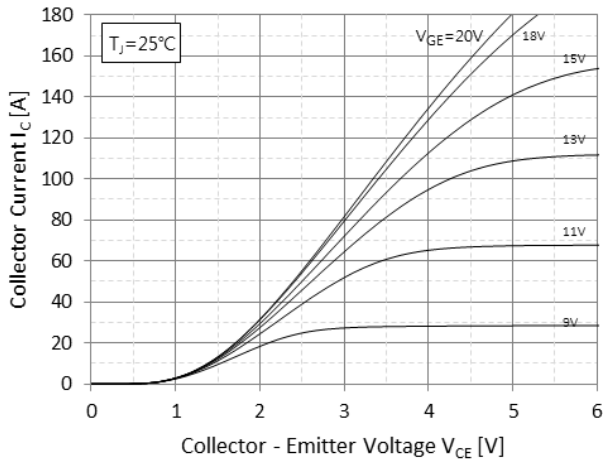


Fig.1 Typical Output Characteristics($T_J=25^\circ\text{C}$)

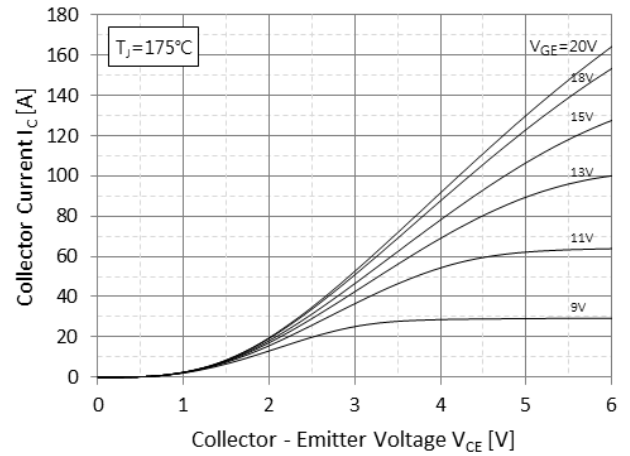


Fig.2 Typical Output Characteristics($T_J=175^\circ\text{C}$)

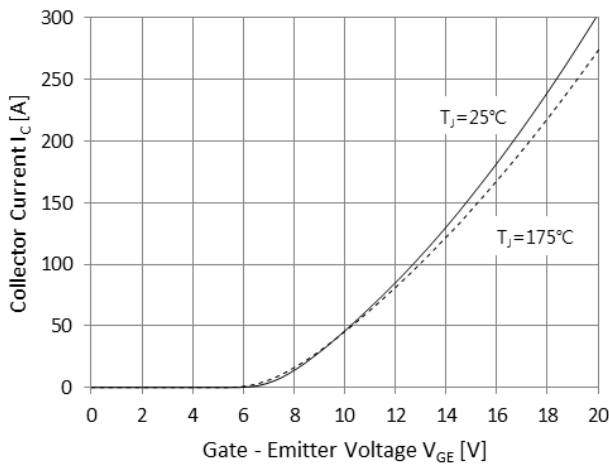


Fig.3 Typical Transfer Characteristics

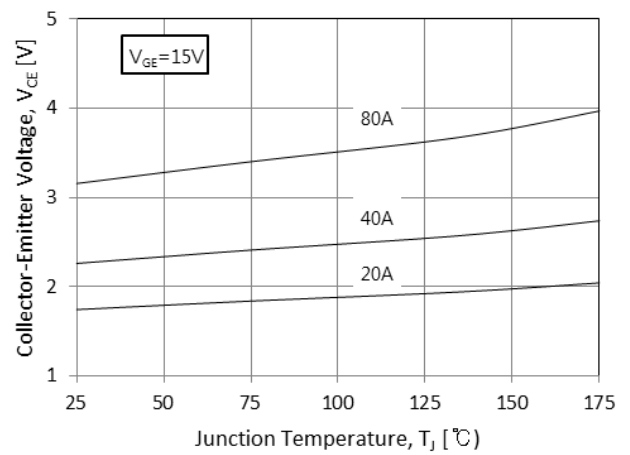


Fig.4 Typical Collector-Emitter Saturation Voltage -Junction Temperature

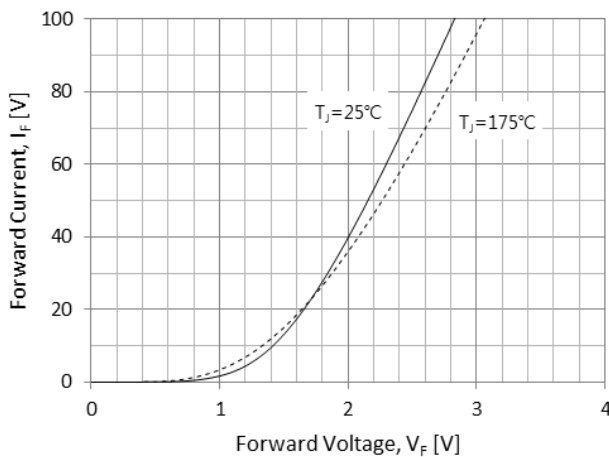


Fig.5 Diode Forward Characteristics

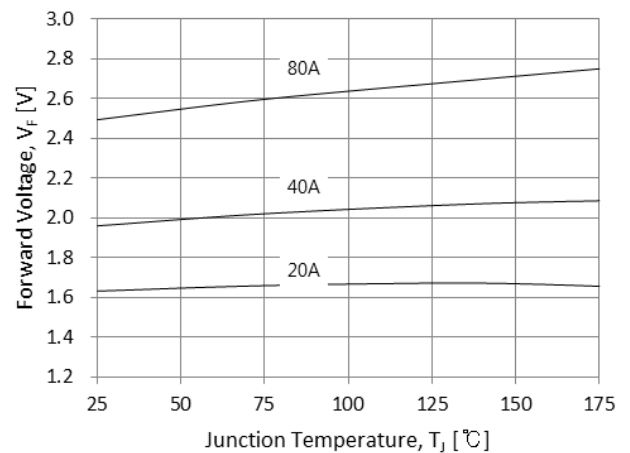


Fig.6 Diode Forward-Junction Temperature

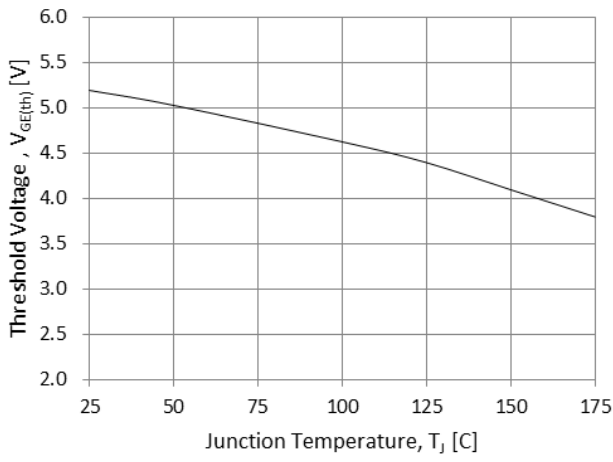


Fig.7 Threshold Voltage-Junction Temperature

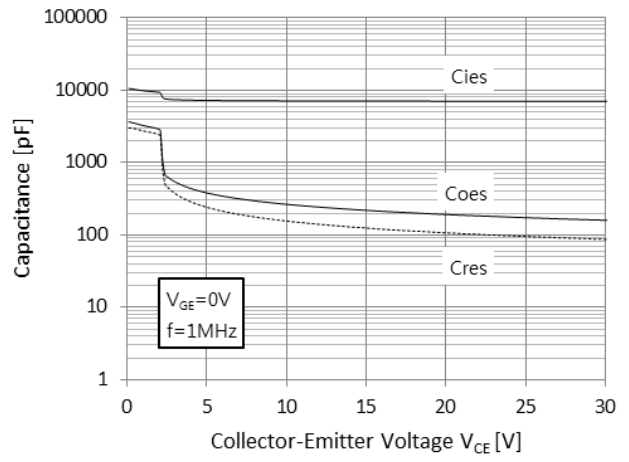


Fig.8 Typical Capacitance

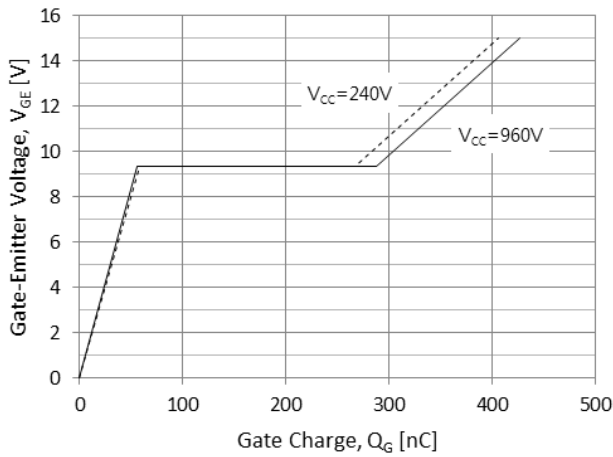


Fig.9 Typical Gate Charge

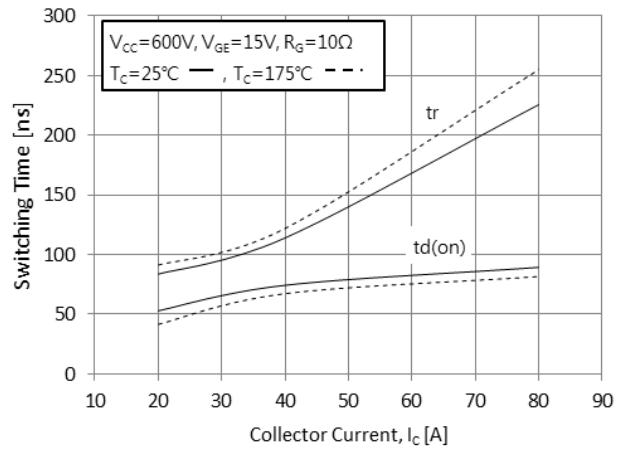


Fig.10 Typical Turn on-Collector Current

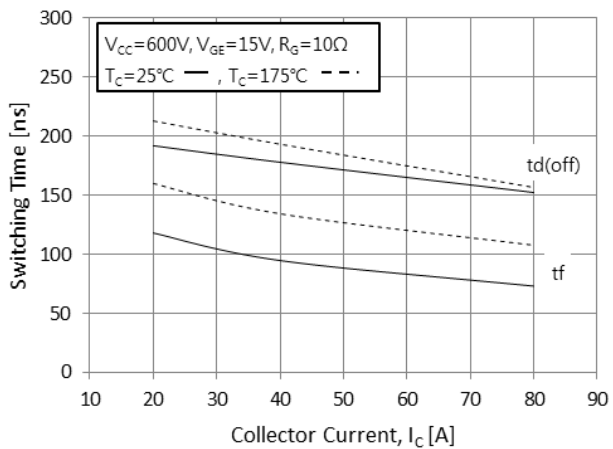


Fig.11 Typical Turn off-Collector Current

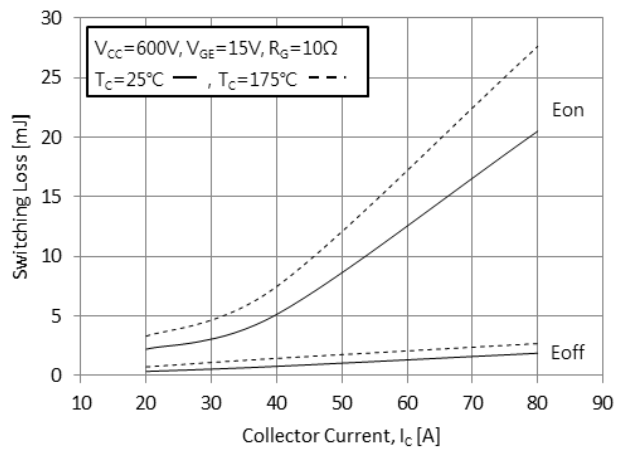


Fig.12 Switching Loss-Collector Current

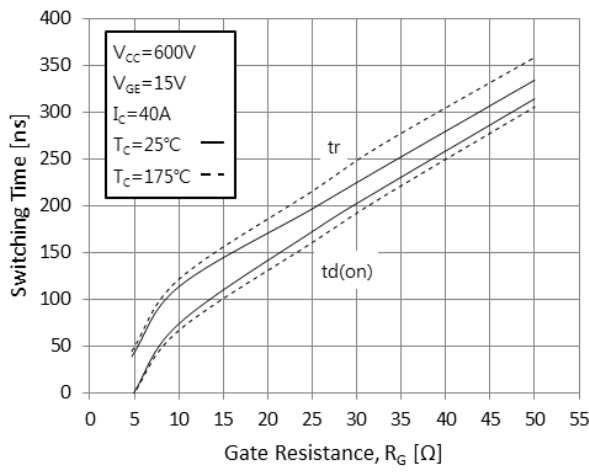


Fig.13 Turn on Characteristics-Gate Resistance

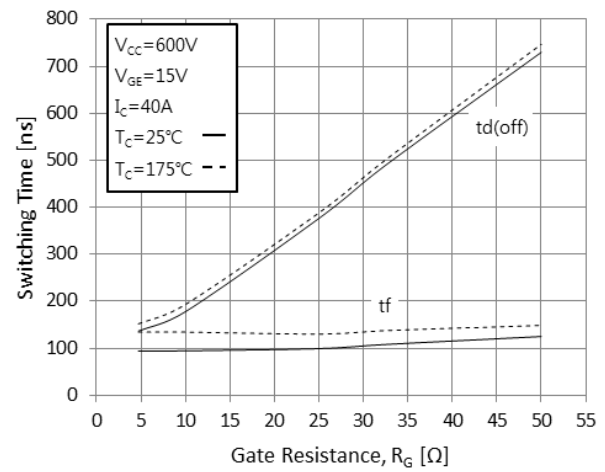


Fig.14 Turn off Characteristics-Gate Resistance

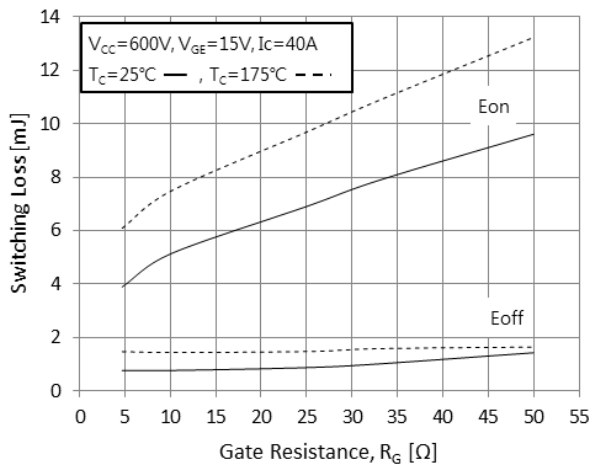


Fig.15 Switching Loss-Gate Resistance

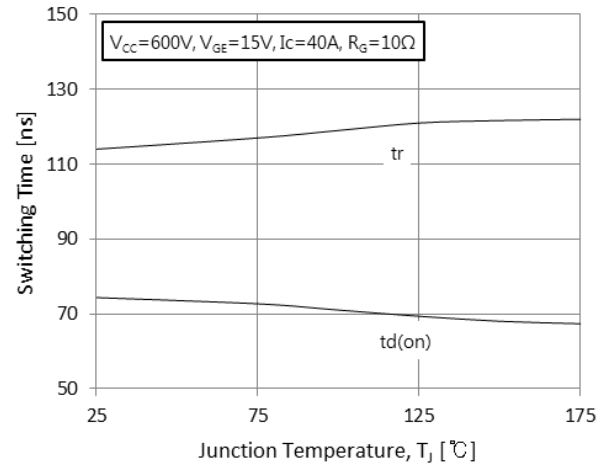


Fig.16 Turn on Characteristics-Junction Temperature

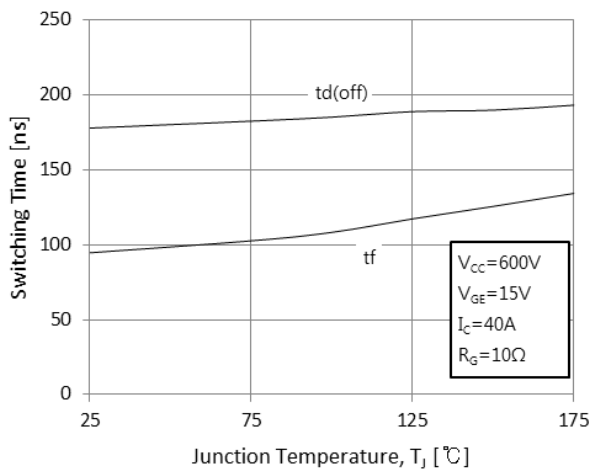


Fig.17 Turn off Characteristics -Junction Temperature

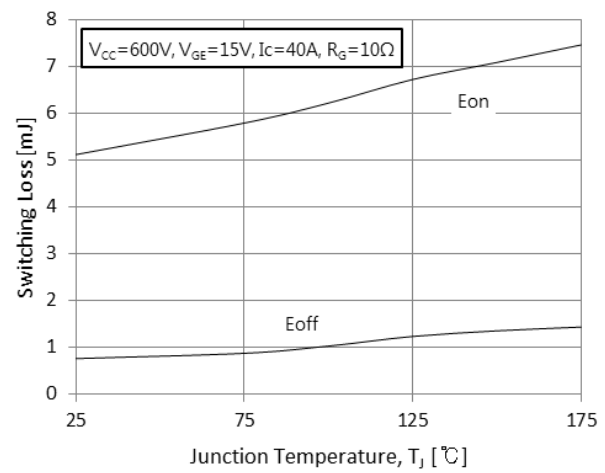


Fig.18 Switching Loss-Junction Temperature

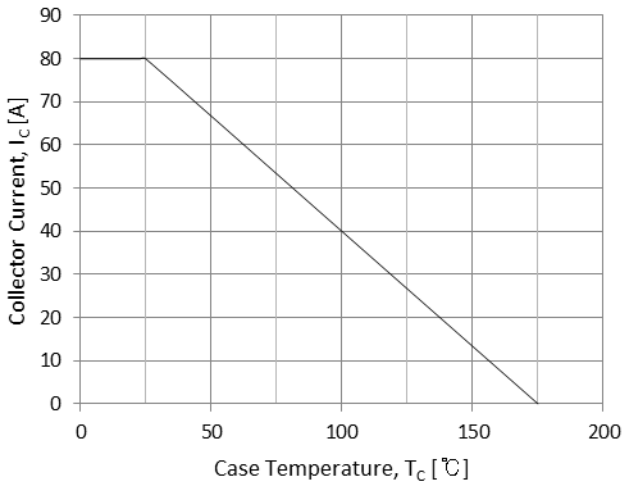


Fig.19 Case Temperature-Collector Current

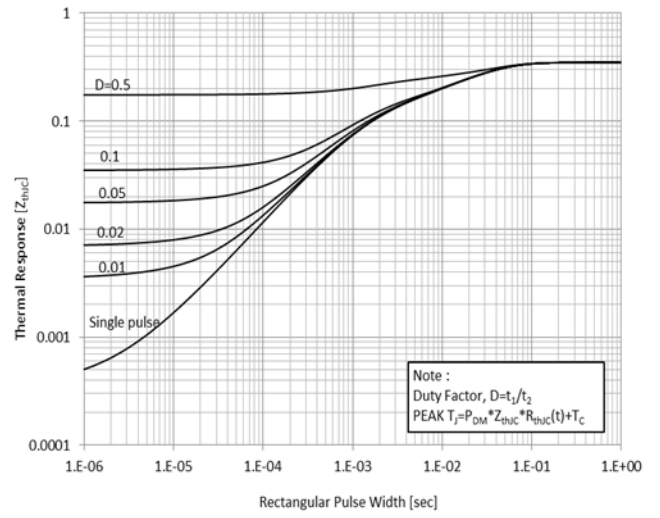


Fig.20 IGBT Transient Thermal Impedance

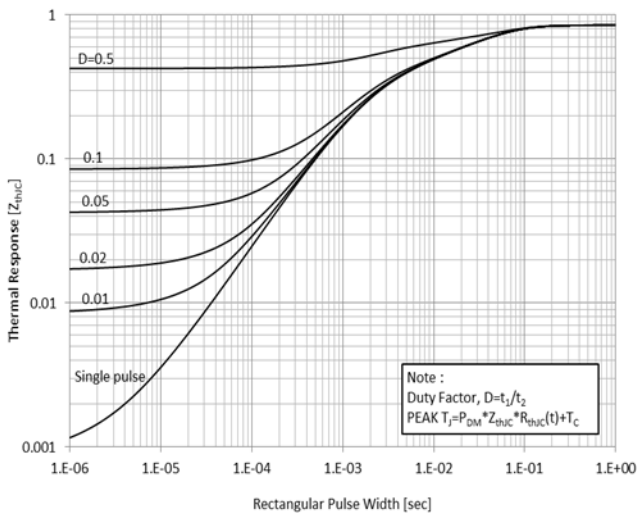
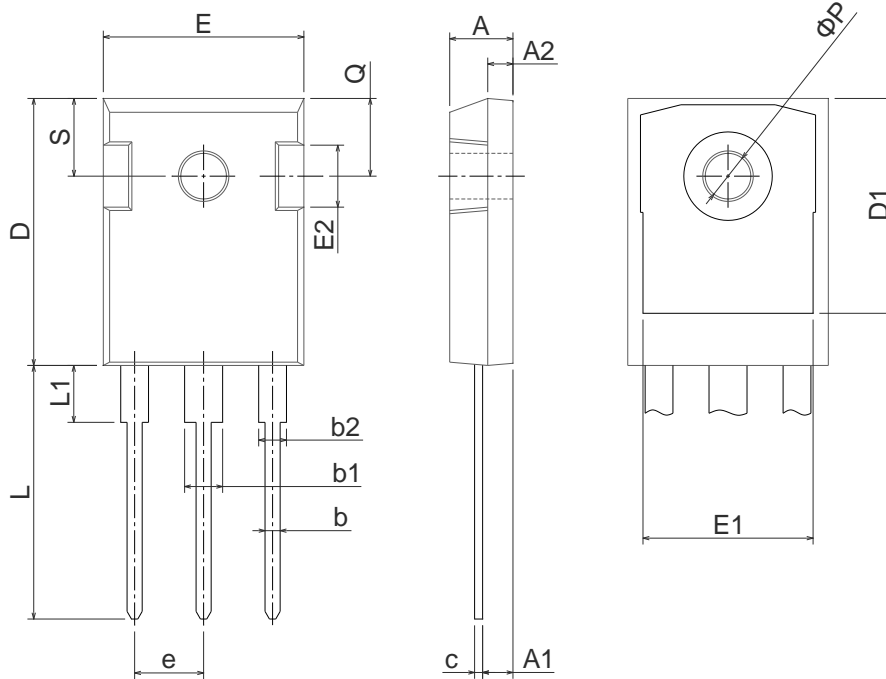


Fig.21 FRD Transient Thermal Impedance

Physical Dimension

TO-247

Dimensions are in millimeters, unless otherwise specified




| Dimension | Min(mm) | Max(mm) |
|-----------|---------|---------|
| A | 4.70 | 5.31 |
| A1 | 2.20 | 2.60 |
| A2 | 1.50 | 2.49 |
| b | 0.99 | 1.40 |
| b1 | 2.59 | 3.43 |
| b2 | 1.65 | 2.39 |
| c | 0.38 | 0.89 |
| D | 20.30 | 21.46 |
| D1 | 13.08 | - |
| E | 15.45 | 16.26 |
| E1 | 13.06 | 14.02 |
| E2 | 4.32 | 5.49 |
| e | 5.45BSC | |
| L | 19.81 | 20.57 |
| L1 | - | 4.50 |
| ΦP | 3.50 | 3.70 |
| Q | 5.38 | 6.20 |
| S | 6.15BSC | |

Note: Package body size, length and width do not include mold flash, protrusions and gate burrs.



DISCLAIMER:

The Products are not designed for use in hostile environments, including, without limitation, aircraft, nuclear power generation, medical appliances, and devices or systems in which malfunction of any Product can reasonably be expected to result in a personal injury. Seller's customers using or selling Seller's products for use in such applications do so at their own risk and agree to fully defend and indemnify Seller.

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